DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence and correspondence address, and citizenship, are as stated below, next to my name and signature.

I believe I am the original, first, and sole inventor (if only one name is below) or joint inventor (if more than one name is below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

MAGNETIC SUBSTANCE WITH MAXIMUM COMPLEX PERMEABILITY IN QUASI-MICROWAVE BAND AND METHOD FOR PRODUCTION OF THE SAME

the specification of which

	is attached hereto	
x	was filed onJanuary 24, 2001	as
	PCT International Application No. PCT/JP01/00437	,
	optionally amended on	

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, \$ 1.56(a).

Priority Claim: I hereby claim priority under 35 U.S.C. § 119, § 120, § 121, and/or §365 as applicable to the following application(s):

Country Application Number Date of Filing Priority Claimed

Japan 52507/2000 January 24, 2000 yes



POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorneys to prosecute this application and transact all business in the U.S. Patent and Trademark Office connected therewith, Hopgood, Calimafde, Judlowe & Mondolino, LLP, a firm comprising Roy C. Hopgood, Reg. No. 15,245; John M. Calimafde,

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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